SPE	FI	$C\Delta I$	NS
OF L		$\Box$	110

CUSTOMER · CSE021

SAMPLE CODE . -

MASS PRODUCTION CODE . PE240160WRT001IY1Q

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 001

DRAWING NO. (Ver.) . LMD-PE240160WRT001IY1Q (Ver.001)

PACKAGING NO. (Ver.) PKG-PE240160WRT001IY1Q (Ver.001)

## **Customer Approved**

Date:

Approved	Checked	Designer
廖志豪 Rex Liao	張慶源 Yuan Chang	陳建成 Louis Chen

☐ Preliminary specification for design input

Specification for sample approval

# 2010.05.28 TW RD APR

#### POWERTIP TECH. CORP.

Headquarters:

No.8, 6<sup>th</sup> Road, Taichung Industrial Park,

Taichung, Taiwan

台中市 407 工業區六路 8 號

TEL: 886-4-2355-8168

FAX: 886-4-2355-8166

E-mail: <a href="mailto:sales@powertip.com.tw">sales@powertip.com.tw</a>

Http://www.powertip.com.tw



## **History of Version**

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
05/26/2010	01	001	Modify cross talk.  Modify 1.4 DC Electrical Characteristics.  Modify 1.5 Optical Characteristics.	- 5~10 11	Louis
		X			

Total : 34 Page



#### Contents

### 1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics

### 2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics
- 2.4 Power circuit

#### 3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

#### 4. RELIABILITY TEST

4.1 Reliability Test Condition

### 5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

### Appendix:

- 1. LCM drawing
- 2. LCM Packaging Specifications

Note: For detailed information please refer to IC data sheet: SITRONIX -ST7529-G



### 1. SPECIFICATIONS

### 1.1 Features

Item	Standard Value		
Display Type	240 * 160 Dots		
LCD Type	FSTN, Negative, Transmissive		
Driver Condition	LCD Module :1/160 Duty, 1/12 Bias		
Viewing Direction	6 O'clock		
Backlight	LED B/L		
Weight	50.4 g		
Interface	8-bit parallel bi-directional interface with 6800-series or 8080-series		
Driver IC	SITRONIX – ST7529-G		
	THIS PRODUCT CONFORMS THE ROHS OF PTC		
ROHS	Detail information please refer web side : <a href="http://www.powertip.com.tw/news/LatestNews.asp">http://www.powertip.com.tw/news/LatestNews.asp</a>		

1.2 Mechanical Specifications

Item	Standard Value			
Outline Dimension	96.2 (W) * 67.2 (L) * 5 (H)			
Viewing Area	80.78 (W) * 54.18 (L)	mm		
Active Area	76.785 (W) * 51.185 (L)	mm		
Dot Size	0.305 (W) * 0.305(H)	mm		
Dot Pitch	0.32 (W) * 0.32 (H)	mm		

Note: For detailed information please refer to LCM drawing

## 1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	$V_{DD}$	_	-0.5	4.0	V
LCD Driver Supply Voltage	$V_{OP}$	V0–VSS	-0.5	20	V
Operating Temperature	$T_OP$	_	-20	70	°C
Storage Temperature.	$T_{ST}$	_	-30	80	°C
Storage Humidity	$H_D$	Ta<60 °C	-	90	%RH



### 1.4 DC Electrical Characteristics

Ta = 25°℃

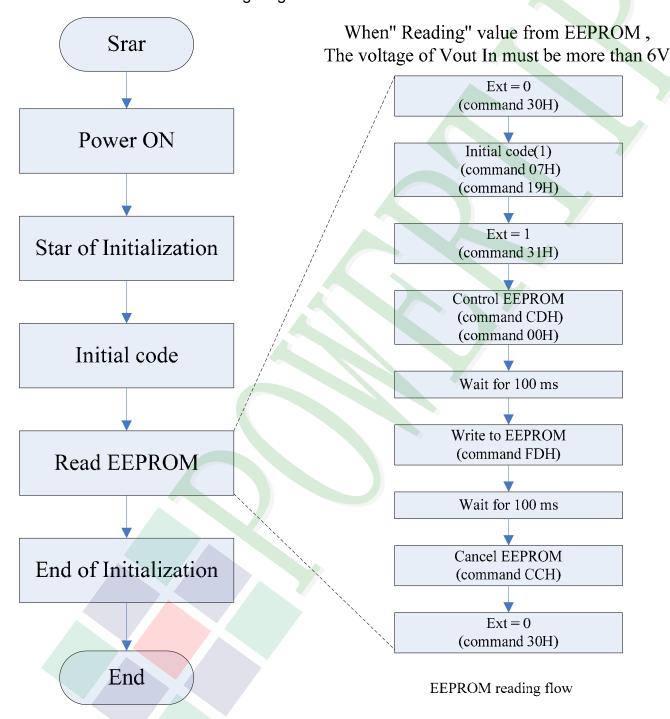
Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Logic Supply Voltage	$V_{dd}$	-	2.7	3.0	3.3	V
"H" Input Voltage	V <sub>IH</sub>	-	0.7V <sub>DD</sub>	1	V <sub>DD</sub>	V
"L" Input Voltage	V <sub>IL</sub>	-	Vss	-	0.3VDD	V
High-level Output Current	ЮН	VDD=2.7V,VOH=2.2V	0.5	-	-	<b>V</b>
Low-level Output Current	IOL	VDD=2.7V,VOL=0.5V	-		-0.5	٧
Supply Current		V <sub>DD</sub> = 3.0V;V <sub>OP</sub> = 15.0V; Pattern= Full display	-	1.5	-	mΛ
Supply Current	I <sub>dd</sub>	V <sub>DD</sub> = 3.0V;V <sub>OP</sub> = 15.0V; Pattern= Net dots*1	1	5	8	mA
	V <sub>OP</sub>	-20℃	17.4	17.5	17.6	
LCM Driver Voltage		<b>25</b> ℃	14.8	15.0	15.2	V
	*2	<b>70</b> ℃	14.0	14.2	14.4	

NOTE: \*1 The Maximum current display;

\*2 The VOP test point is V0~VSS.



\*3 The ST7529 offer read Electronic Control value function from the built-in EEPROM, Must set up and carry out in initial value in order to avoid that it is unusual to export Please see the following diagram.





#### \*4 Initial code

MOV	A,#00110000B	;EXT=0 SET
CALL	WRITE_COM	
MOV	– A,#11010001B	;INTERNAL OSCILLATION ON
CALL	WRITE_COM	
MOV	– A,#10010100B	;SLEEP OUT
CALL	WRITE_COM	
MOV	A,#11001010B	;DISPLAY CONTROL(CL,DUTY,FR)
CALL	WRITE_COM	
MOV	A,#0000000B	;CL DIVIDING RATIO(CLD=0)
CALL	WRITE_DATA	
MOV	A,#00100111B	;DRIVE DUTY(1/160 = 160/4 -1=39)
CALL	WRITE_DATA	
MOV	A,#0000000B	;FR INVERSE-SET VALUE
CALL	WRITE_DATA	
MOV	A,#10111011B	;COMMON SCAN DIRECTON
CALL	WRITE_COM	
MOV	A,#0000001B	;SET COM0->COM79,COM159->COM80
CALL	WRITE_DATA	
MOV	A,#1000001B	;ELECTRONIC VOLUME CONTROL
CALL	WRITE_COM	
MOV	A, #00011101B	;SETTING VOLUME VALUE
CALL	WRITE_DATA	
MOV	A,#00000100B	;SETTING BUILT-IN RESISTANCE VALUE3.6+(285*0.04)=15.0
CALL	WRITE_DATA	
MOV	A,#00100000B	;POWER CONTROL SET
CALL	WRITE_COM	
MOV	A,#00001011B	;VR=1,VF=1,VB=1 Internal VLCD
CALL	WRITE_DATA	



<u> </u>	1111	
MOV	A,#10100111B	;INVERSE DISPLAY
CALL	WRITE_COM	
MOV	A,#10101001B	;PARTIAL OUT
CALL	WRITE_COM	
MOV	A,#10111100B	;DATA SCAN DIRECTION
CALL	WRITE_COM	
MOV	A,#0000010B	;NORMAL/INVERSE DISPLAY OF (THE LINE
CALL	WRITE_DATA	;AND ADDRESS SCAN DIRECTION
MOV	A,#0000001B	;NOT USED,D0 MUST BE 0
CALL	WRITE_DATA	
MOV	A,#00000100B	;GRAY-SCALE SETUP(3B3P 2MODE)
CALL	WRITE_DATA	
MOV	A,#01110101B	;LINE ADDRESS SET
CALL	WRITE_COM	
MOV	A,#0000000B	;START LINE SET 00
CALL	WRITE_DATA	
MOV	A,#159	;END LINE SET 159
CALL	WRITE_DATA	
MOV	A,#00010101B	;COLUMN ADDRESS SET
CALL	WRITE_COM	
MOV	A,#5	;START COLUMN SET 00
CALL	WRITE_DATA	
MOV	A,#84	;END COLUMN SET (84-5+1=80 80*3=240)
CALL	WRITE_DATA	
MOV	A,#00110001B	;EXT=1 SET
CALL	WRITE_COM	
MOV	A,#00110010B	;Analog circuit set
CALL	WRITE_COM	
MOV	A,#0000000B	;OSC Frequency 12.7KHZ



CALL WRITE\_DATA

MOV A,#00000001B ;Booster Efficiency Set 6KHZ

CALL WRITE\_DATA

MOV A,#00000010B ;Bias Set 1/12

CALL WRITE DATA

MOV A,#00110100B ;Dithering OFF

CALL WRITE\_COM

MOV A,#00110000B ;EXT=0 SET

CALL WRITE\_COM

MOV A,#00000111B ;

CALL WRITE\_COM

MOV A,#00011001B

CALL WRITE\_DATA

MOV A,#00110001B ;EXT=1 SET

CALL WRITE\_COM

MOV A,#11001101B

CALL WRITE COM

MOV A,#0000000B

CALL WRITE DATA

CALL DELAY00

CALL DELAY00

CALL DELAY00

CALL DELAY00

CALL DELAY00

MOV A,#11111101B

CALL WRITE COM

CALL DELAY00

CALL DELAY00



CALL DELAY00

CALL DELAY00

CALL DELAY00

MOV A,#11001100B

CALL WRITE\_COM

MOV A,#00110000B ;EXT=0 SET

CALL WRITE\_COM

MOV A,#10101111B ;DISPLAY ON

CALL WRITE\_COM



### 1.5 Optical Characteristics

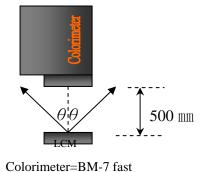
LCD Panel: 1/160 Duty, 1/12 Bias,  $V_{LCD} = 15.0V$ , Ta =  $25^{\circ}C$ 

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
Doonongo Timo	Rise	tr	<b>25</b> ℃	1	150	225	me	Noto?
Response Time	Fall	tf	<b>25</b> ℃	-	450	675	ms	Note2
	Тор	⊖ <b>Y</b> +		-	25	-		
Viewing angle	Bottom	⊖ <b>Y</b> -	CR <u>&gt;</u> 2.0,	-	40	-	dograd	Note 1
range	Left	⊖ <b>X</b> -	Ø <b>=270</b> °	-	45	-	degree	Note i
	Right	⊕ <b>X</b> +		-	45	-		
Contrast Ra	tio	CR	θ = 0°, ∅ =270°		30	-	-	Note 3
Average Bright (With LED B		IV	IF= 40 mA	90	130	1	cd/m <sup>2</sup>	1
CIE Color Coor	dinate	X		0.21	0.26	0.31	ı	
(With LED B	/L)	Υ	IF= 40 mA	0.21	0.26	0.31	-	Note 4
Uniformity	1	∆B		70	-	-	%	

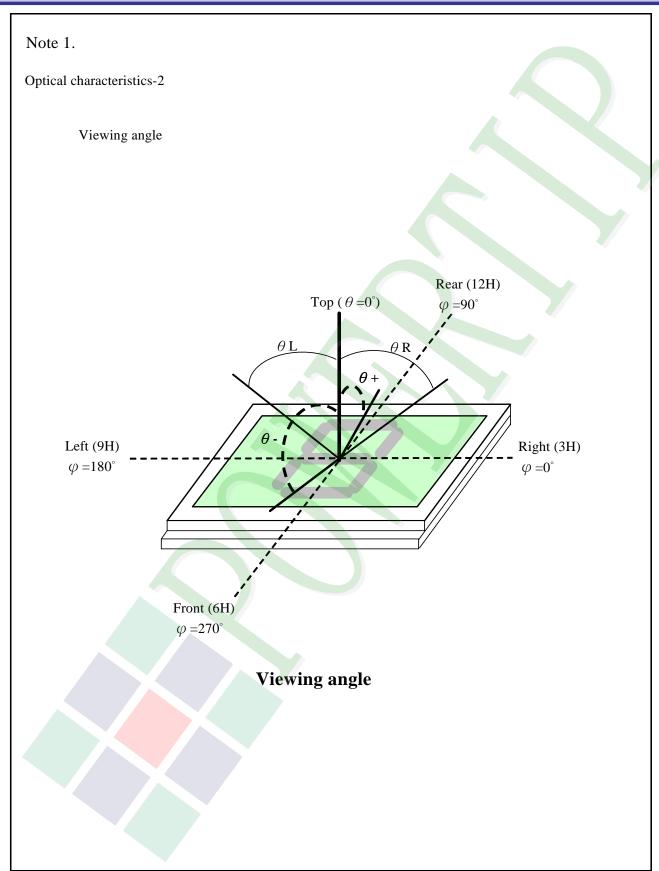
#### Note 4:

- 1 : △B=B(min) / B(max) \* 100%
- 2 : Measurement Condition for Optical Characteristics:
  - a: Environment: 25 ±5 / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.
  - b : Measurement Distance:  $500 \pm 50 \text{ mm}$ ,  $(\theta = 0^{\circ})$
  - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
  - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%

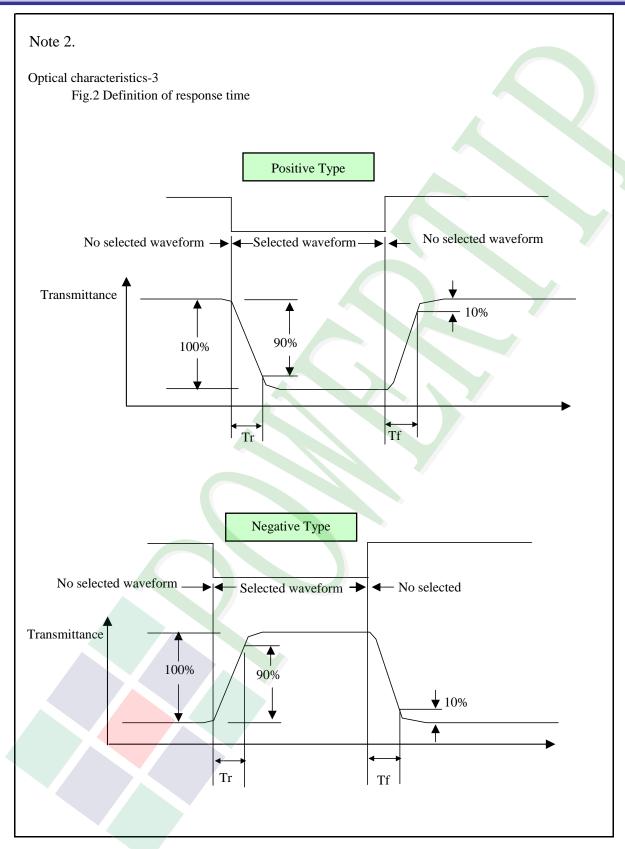












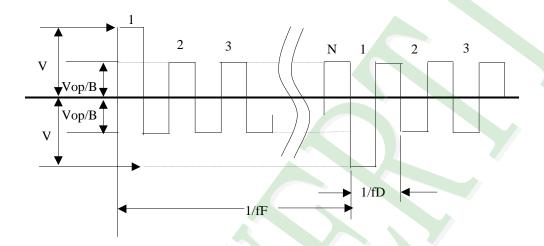


#### Electrical characteristics-2

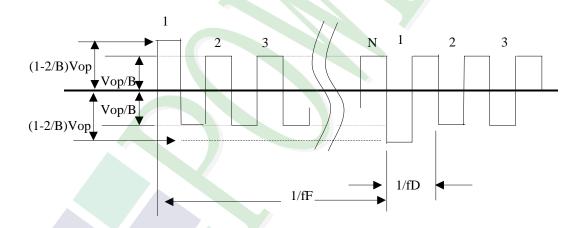
2 Drive waveform

Vop: Drive voltage fF: Frame frequency 1/B: Bias fD: Drive frequency N: Duty

#### (1) Selected waveform



#### (2) Non- Selected wave form

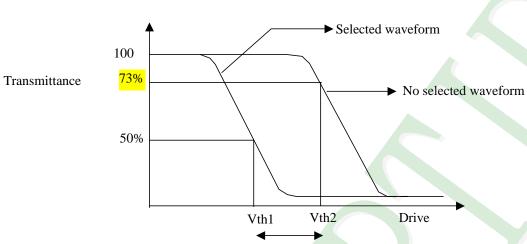


#### Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period







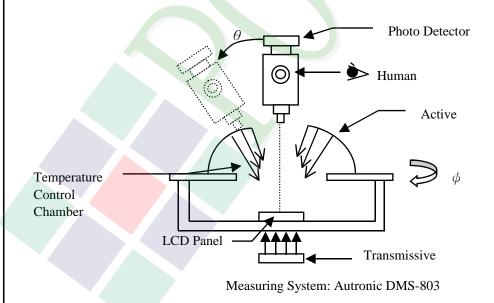
Active voltage range

	Vth1	Vth2
View direction	10°	40°
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

#### **※**1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

#### Outline of Electro-Optical Characteristics Measuring System





## 1.6 Backlight Characteristics

## LED Backlight

Maximum Ratings

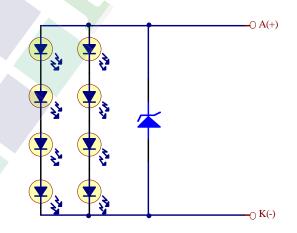
Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	I <sub>F</sub>		-	50	mA
Reverse Voltage	V <sub>R</sub>	Ta =25°C		20	V
Power Dissipation	PD		-	0.7	W
Operating Temperature	T <sub>OP</sub>	-	-20	70	°C
Storage Temperature.	T <sub>ST</sub>	-	-30	80	°C

### Electrical / Optical Characteristics

Ta =25°℃

						- 0
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF			12.8	14	V
Reverse Current	IR	IF= 40mA	-//	-	0.1	mA
Average Brightness (Without LCD)	IV	IF= 40mA	650	-	-	cd/m <sup>2</sup>
CIE Color Coordinate	X		0.27	ı	0.33	ı
(Without LCD)	Y		0.27	-	0.33	-
Uniformity	∆B		70	-	-	%
Color			WHITE			

### Internal Circuit Diagram:





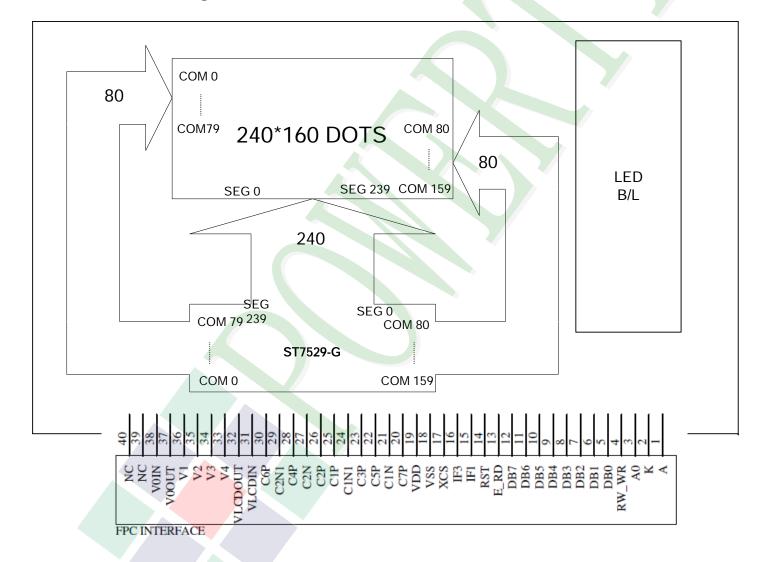
### 2. MODULE STRUCTURE

### 2.1 Counter Drawing

## 2.1.1 LCM Mechanical Diagram

\* See Appendix

### 2.1.2 Block Diagram





## 2.2 Interface Pin Description

Pin No.	Symbol			Function		
1	Α	Power supply for LED	ower supply for LED Backlight Anode input.			
2	K	Power supply for LED	Backlight (	Cathode input.		
3	A0	Register select input pi A0 = "H":DB0 to DB7 a A0 = "L":DB0 to DB7 a	are display			
		Read / Write execution				
4	RW_WR	MPU type 8080-series	RW_WR /WR	Description Write enable clock input pin. The data on D0 to D15 are latched at the rising edge of the /WR signal.		
		6800-series	RW	Read / Write control input pin RW = "H" : read RW = "L" : write		
5	DB0					
6	DB1					
7	DB2					
8	DB3			oit MPU bus via the 8-bit bi-directional bus. elected and the XCS pin is high, the following		
9	DB4			nich should be fixed to VDD or VSS.		
10	DB5					
11	DB6					
12	DB7					



Pin No.	Symbol		Function				
		Read / Write	Read / Write execution control pin.				
		MPU Type	pe E_RD		Description		
		8080-series	/RD	Read e	nable clock input pin.		
		0000-301103	//\D	When /	RD is "L", D0 to D15 are in an	output status.	
13	E_RD				Write control input pin		
				-RW =	"H": When E is "H", DB0 to DB	15 are in an	
		6800-series	Е	output	status.		
				-RW =	"L": The data on DB0 to DB15	are latched at	
				the falli	ng edge of the E signal.	~/	
14	RST	Reset input pi	n.			>	
14	1.01	When RST is	"L", initia	alization	is executed.		
		Parallel / Seria	al data ir	nput sele	ect input.		
15	IF1	IF1	IF	=3	MPU interface type		
		Н		Ĺ	80 series 8-bit parallel.		
16	IF3	L		Н	68 series 8-bit parallel.		
		Chip select in	put pins.				
17	XCS	Data/instruction I/O is enabled only when XCS is "L". When chip select is					
		non-active, DI	30 to DB	37 may b	e high impedance.		
18	VSS	System Groun	nd.				
19	VDD	Power Supply					
20	C7P	DC / DC volta	ge conve	erter. Co	onnect a capacitor between this	s terminal and	
20	U/F	the VSS termi	nal.		7		



Pin No.	Symbol	Function
21	0411	DC / DC voltage converter. Connect a capacitor between this terminal and
21	C1N	the C5P terminal.
22	C5P	DC / DC voltage converter. Connect a capacitor between this terminal and
22	CoP	the C1N terminal.
23	C3P	DC / DC voltage converter. Connect a capacitor between this terminal and
23	CSF	the C1N1 terminal.
24	C1N1	DC / DC voltage converter. Connect a capacitor between this terminal and
24	CINI	the C3P and C1P terminal.
25	C1P	DC / DC voltage converter. Connect a capacitor between this terminal and
25	Oll	the C1N1 terminal.
26	C2P	DC / DC voltage converter. Connect a capacitor between this terminal and
20	021	the C2N terminal.
27	C2N	DC / DC voltage converter. Connect a capacitor between this terminal and
21	0211	the C2P and C4P terminal.
28	C4P	DC / DC voltage converter. Connect a capacitor between this terminal and
20	O+1	the C2N terminal.
29	C2N1	DC / DC voltage converter. Connect a capacitor between this terminal and
20	02111	the C6P terminal.
30	C6P	DC / DC voltage converter. Connect a capacitor between this terminal and
		the C2N terminal.
		An external LCD supply voltage can be supplied using the VLCDIN pad. In
31	VLCDIN	this case, VLCDOUT has to be left open, and the internal voltage generator
		has to be programmed to zero. (SET register V B=0)
		If the internal voltage generator is used, the V LCDIN & VLCDOUT must be
32	VLCDOUT	connected together.
		If an external supply is used, this pin must be left open.

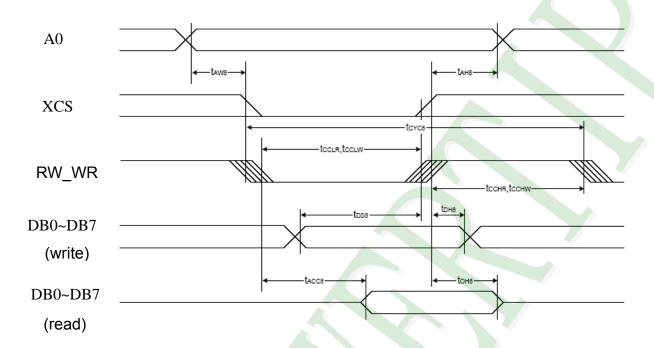


Pin No.	Symbol		Function				
33	V4	LCD driver supp	oly voltages				
34	V3	V0In & V0out sl Voltages should		cted together in ving relationship			
35	V2	V0 ≥ V1 ≥ V2 ≥		9			
36	V1	When the interr following table a	•			enerated as the	
37	V0OUT	LCD bias	V1	V2	V3	V4	
20	VOIN	1/N bias	(N-1)/N * V0	(N-2)/N * V0	(2/N) * V0	(1/N) * V0	
38	VUIN	NOTE:N=5 to 1	4.				
39	NC	Not Connection					
40	NC	Not Connection					



### 2.3 Timing Characteristics

System Bus Read/Write Characteristics (For the 8080 Series MPU)

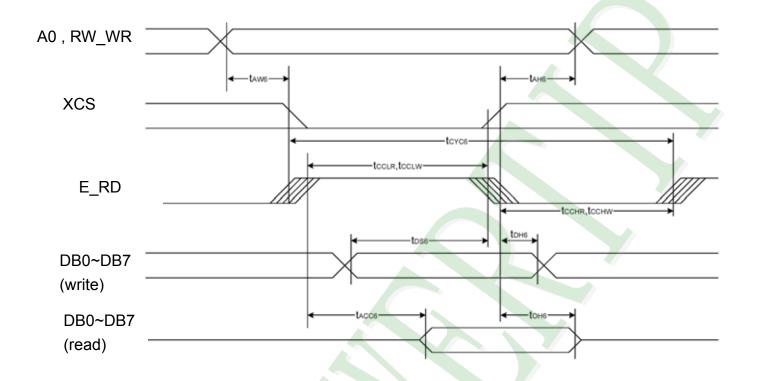


 $(VDD = 3.3 \text{ V}, Ta = -20 \sim 85^{\circ}\text{C})$ 

Item	Signal	Symbol	Condition	Rati	ng	Units
nem	Olgital	Cymbol	Condition	Min.	Max.	Office
Address hold time		tAH8	-	20	1	
Address setup time	A0	tAW8	-	20	ı	
System cycle time		tCYC8	-	200	-	
Enable L pulse width(WRITE)	RW WR	tCCLW	-	100	-	
Enable H pulse width(WRITE)	KVV_VVK	tCCHW	-	100	-	
Enable L pulse width(READ)	RW WR	tCCLR	-	100	ı	ns
Enable H pulse width(READ)	KVV_VVK	tCCHR	-	100	ı	
WRITE Data setup time		tDS8	-	150	1	
WRITE Address hold time	D0 TO D15	tDH8	-	20	-	
READ access time	D0 10 D15	tACC8	CL=100pF	-	40	
READ Output disable time		tOH8	CL=100pF	-	30	



### System Bus Read/Write Characteristics (For the 6800 Series MPU)

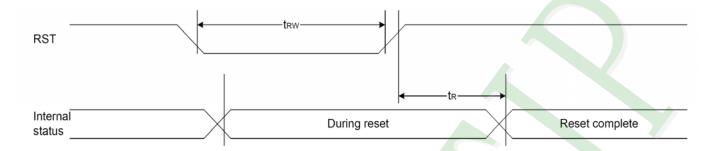


$$(VDD = 3.3 \text{ V}, Ta = -20 \sim 85^{\circ}\text{C})$$

Item	Signal	Symbol	Condition	Rating		Units
nem	TAH6 - 20 -		Min. Max		Office	
Address hold time		TAH6	-	20	-	
Address setup time	A0	TAW6	-	20	-	
System cycle time		TCYC6	-	200	-	
Enable L pulse width(WRITE)	E RD	tEWLW	-	100	-	
Enable H pulse width(WRITE)	E_RD	tEWHW	-	100	-	
Enable L pulse width(READ)	E RD	tEWLR	-	100	-	ns
Enable H pulse width(READ)	E_KD	tEWHR	-	100	-	
WRITE Data setup time		tDS6	-	150	-	
WRITE Address hold time	D0 TO D15	tDH6	-	20	-	
READ access time	D0 10 D15	tACC6	CL=100pF	-	40	
READ Output disable time		tOH6	CL=100pF	-	30	



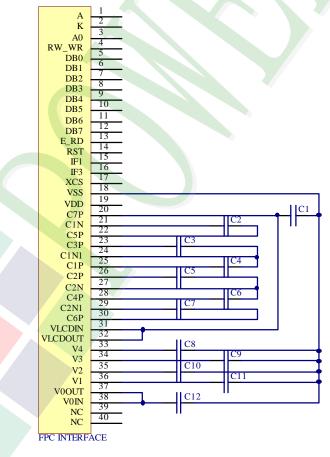
#### Reset timing



 $(VDD = 3.3 \text{ V}, Ta = -20 \sim 85^{\circ}\text{C})$ 

Item	Signal	Signal Symbol Condition Ra		Rati	ng	Units
no	Oigi ai	Cymbol	Condition	Min.	Max.	Ormo
Reset time		tR	-	- 4	1	us
Reset "L" pulse width	RST	tRW	-	1	-	us

### 2.4 Power circuit



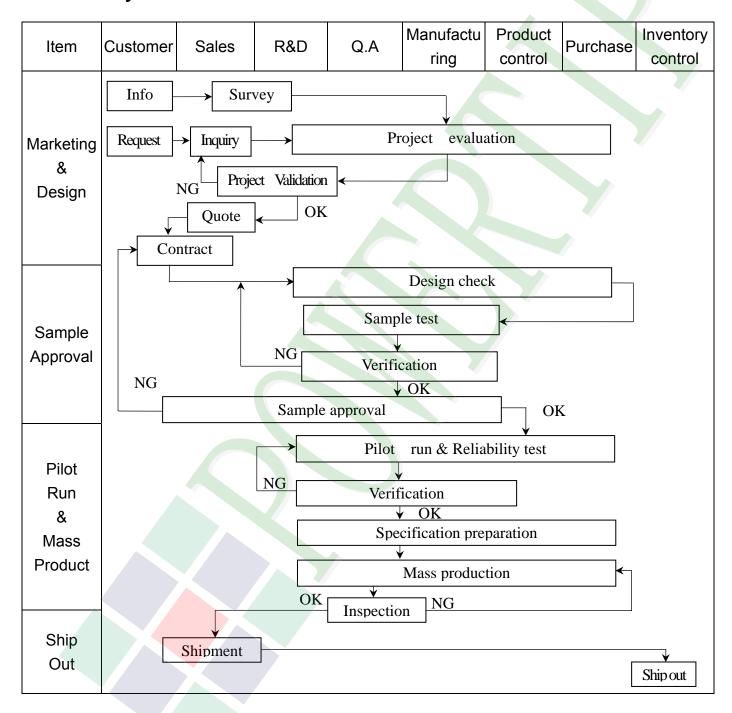
NOTE:Booste:7X(internal)

C1~C12=1~2.2uF/25V

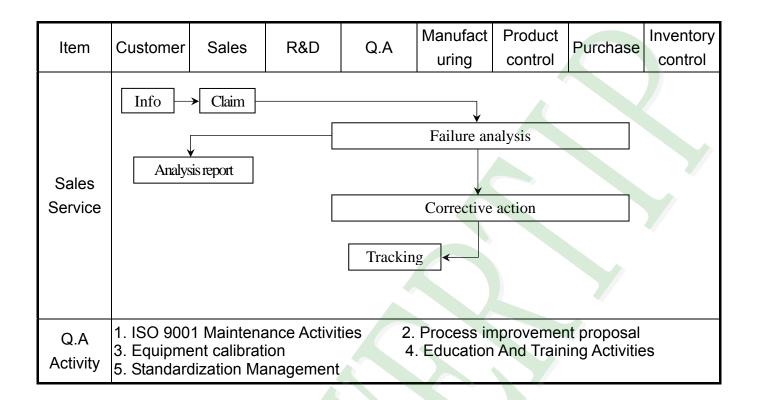


### 3. QUALITY ASSURANCE SYSTEM

## 3.1 Quality Assurance Flow Chart









#### 3.2 Inspection Specification

- ◆Scope: The document shall be applied to LCD Module for Monotype and Color STN(Ver. B01).
- ◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect: AQL: 1.5.
- **♦**OUT Going Defect Level : Sampling .
- ◆Manner of appearance test:
  - (1). The test be under 20W×2 fluorescent light 'and distance of view must be at 30 cm.
  - (2). Standard of inspection: (Unit: mm)
  - (3). The test direction is base on about around 45° of vertical line. (Fig. 1)
  - (4). Definition of area . (Fig. 2)

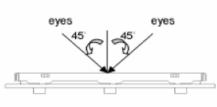


Fig.1

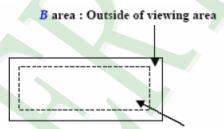


Fig. 2 A area: viewing area

#### ◆ Specification:

NO	Item	Criterion	Level
		1. 1 The part number is inconsistent with work order of Production.	Major
01	Product condition	1. 2 Mixed production types.	Major
		1. 3 Assembled in inverse direction.	Major
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3. 1 Product dimension and structure must conform to Structure diagram.	Major
		4. 1 Missing line character and icon.	Major
		4, 2 No function or no display.	Major
04	Electrical Testing	4. 3 Output data is error.	Major
		4. 4 LCD viewing angle defect.	Major
		4. 5 Current consumption exceeds product specifications.	Major



NO	Item		C	riteri	on			Level
	Black or white dot \ scratch \ contamination	<ul> <li>5. 1 Round type:</li> <li>5. 1. 1 display only:</li> <li>• White and black spots on display ≤ 0. 30 mm, no more than 4 white or black spots present.</li> <li>• Densely spaced: NO more than two spots or lines within 3 mm.</li> </ul>						
	Round type		play : ension ter : Φ)		Acceptance A area		y) area	
05	$\begin{array}{c c} X & \hline \\ Y & \hline \end{array}$	0.10 <	$\Phi \le 0.10$ $\Phi \le 0.20$ $\Phi \le 0.30$		ept no dense		gnore	Minor
	$\Phi = (x+y)/2$		$\Phi \ge 0.50$ uantity		4			
	Line type	5. 1. 3 Line typ Di Length (L)	e: imension Width (W)		Accep A area	otanc	e (Q'ty) B area	
	$\longrightarrow \stackrel{\stackrel{\longleftarrow}{}}{\underset{L}{\longleftarrow}} W$		$W \le 0$ $03 < W \le 0$ $05 < W \le 0$	. 05	Accept no de	nse	Ignore	
		/	$\mathbf{W} > 0$ .		As	roun	d type	
		Dimen		Acceptance (		ce (Q		
		(diamete	$(\mathbf{r}: \mathbf{\Phi})$ $\leq 0.20$	A area Accept no dense			B area	
06	Polarizer	0. 20 < Φ	≤ 0.50	3				Minor
	Bubble	0.50 <Φ			2		Ignore	
		Φ Total qu	> 1.00		4			



NO	Item	Criterion		Level
		Symbols:  X: The length of crack Z: The thickness of crack t: The thickness of glass  X: The width of the wid	igth	
		7. 1 General glass chip: 7. 1. 1 Chip on panel surface and crack between par	iels:	
		Z Z	Y	
07	The crack of glass	SP SP SP (NG)		Minor
		Seal width Z		
		X Y Z		
		≤ a Crack can't enter viewing area ≤1.	/2 t	
		≤ a Crack can't exceed the half of SP width. 1/2 t <	Z ≤2 t	



NO	Item	Criterion	Level
		Symbols:  X: The length of crack Y: The width of crack. Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length	<b>Y</b>
		7.1.2 Corner crack:	
		$X$ $Y$ $Z$ $\leq 1/5 \text{ a} \qquad \text{Crack can't enter} \qquad Z \leq 1/2 \text{ t}$ $\text{viewing area} \qquad Z \leq 1/2 \text{ t}$	
07	The crack of glass		Minor
		7. 2 Protrusion over terminal: 7. 2. 1 Chip on electrode pad:	
		Z X Z Z Z	
		W	
		$\begin{array}{c cccc} X & Y & Z \\ \hline Front & \leq a & \leq 1/2 \text{ W} & \leq t \\ \end{array}$	
		Back Neglect	



NO	Item	Criterion L	
		Symbols:  X: The length of crack Z: The thickness of crack t: The thickness of glass  X: The width of crack W: terminal length a: LCD side length	<b>&gt;</b> /
07	The crack of glass	7. 2. 2 Non-conductive portion:    X	Minor



			ver.bor/
NO	Item	Criterion	Level
08	Backlight elements	8. 1 Backlight can't work normally.	Major
		8. 2 Backlight doesn't light or color is wrong.	Major
		8. 3 Illumination source flickers when lit.	Major
09	General appearance	9. 1 Pin type must match type in specification sheet.	Major
		9. 2 No short circuits in components on PCB or FPC.	Major
		9. 3 Product packaging must the same as specified on packaging specification sheet.	Minor
		9. 4 The folding and peeled off in polarizer are not acceptable.	Minor
		9. 5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≤1.5 mm.	Minor



### 4. RELIABILITY TEST

## 4.1 Reliability Test Condition

1 High Temperature Storage Test Surrounding temperature, then storage at normal condition 4hrs.  2 Low Temperature Storage Test Surrounding temperature, then storage at normal condition 4hrs.  3 High Temperature / High Humidity Storage Test Surrounding temperature, then storage at normal condition 4hrs.  Keep in +30 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.  Keep in +60 °C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs.  (Excluding the polarizer)  -30°C → +25°C → +80°C → +25°C (30mins) (5mins) (30mins) (5mins)  10 Cycle Surrounding temperature, then storage at normal condition 4hrs.  Air Discharge: Contact Discharge: Apply 250 V with 5 times Discharge for each polarity +/-  1. Temperature ambiance : 15°C ~35°C 2. Humidity relative : 30% ~60% 3. Energy Storage Capacitance (Cs+Cd) : 150pF±10% 4. Discharge Resistance (Rd) : 330Ω±10% 5. Discharge, mode of operation :  Single Discharge (time between successive discharges at least 1 s (Tolerance if the output voltage indication : ±5%)  1. Sine wave 10 55 Hz frequency (1 min/sweep) 2. The amplitude of vibration :1.5 mm 3. Each direction (X · Y · Z) duration for 2 Hrs  Packing Weight (Kg) Drop Height (cm)  0 ~ 45.4 122  45.4 ~ 90.8 76  90.8 ~ 454 61  Over 454 46	NO.	TEST ITEM	TEST CONDITION			
Storage Test    High Temperature / High Humidity Storage Test   Keep in +60 °C / 90% R.H duration for 96 hrs	_	High Temperature	Keep in +80 ±2°C 96 hrs			
Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)    Temperature Cycling Storage Test   Contact Discharge:   Contact Discharge:   Apply 25 V with 5 times   Apply 25 V with 5 times   Discharge for each polarity +/-   1. Temperature ambiance : 15 ℃ ~ 35 ℃   2. Humidity relative : 30% ~ 60%   3. Energy Storage Capacitance(Cs+Cd) : 150pF±10%   4. Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 s (Tolerance if the output voltage indication : ±5%)    Vibration Test (Packaged)   Packing Weight (Kg)   Drop Height (cm)   0 ~ 45.4   122   45.4 ~ 90.8   76   90.8 ~ 454   61   10.5 mm   1.5 m	2	_	1			
Temperature Cycling Storage Test  (30mins) (5mins) (30mins) (5mins)  10 Cycle  Surrounding temperature, then storage at normal condition 4hrs.  Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/-  1. Temperature ambiance: 15℃ ~35℃ 2. Humidity relative: 30% ~60% 3. Energy Storage Capacitance(Cs+Cd): 150pF±10% 4. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 s (Tolerance if the output voltage indication: ±5%)  1. Sine wave 10 55 Hz frequency (1 min/sweep) 2. The amplitude of vibration: 1.5 mm 3. Each direction (X \ Y \ Z) duration for 2 Hrs  Packing Weight (Kg) Drop Height (cm)  0 ~ 45.4 122  45.4 ~ 90.8 76  90.8 ~ 454 61	3	High Humidity	Surrounding temperature, then storage at normal condition 4hrs.			
Apply 2 KV with 5 times Discharge for each polarity +/-  1. Temperature ambiance : $15^{\circ}$ C $\sim 35^{\circ}$ C  2. Humidity relative : $30\% \sim 60\%$ 3. Energy Storage Capacitance(Cs+Cd) : $150pF\pm10\%$ 4. Discharge Resistance(Rd) : $330\Omega\pm10\%$ 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 s (Tolerance if the output voltage indication : $\pm 5\%$ )  1. Sine wave 10 55 Hz frequency (1 min/sweep) 2. The amplitude of vibration :1.5 mm 3. Each direction (X \cdot Y \cdot Z) duration for 2 Hrs  Packing Weight (Kg) Drop Height (cm) 0 $\sim 45.4$ 122 45.4 $\sim 90.8$ 76 90.8 $\sim 454$ 61	4		(30mins) (5mins) (5mins)  10 Cycle			
7 Vibration Test (Packaged)  2. The amplitude of vibration :1.5 mm 3. Each direction (X \ Y \ Z) duration for 2 Hrs  Packing Weight (Kg) Drop Height (cm)  0 ~ 45.4 122  45.4 ~ 90.8 76  90.8 ~ 454 61	5	ESD Test	Apply 2 KV with 5 times  Discharge for each polarity +/-  1. Temperature ambiance: 15℃  2. Humidity relative: 30%~60%  3. Energy Storage Capacitance(€  4. Discharge Resistance(Rd): 33€  5. Discharge, mode of operation  Single Discharge (time between section)	Apply 250 V with 5 times discharge for each polarity +/- ~35°C 6 Cs+Cd): 150pF±10% 0Ω±10% : successive discharges at least 1 sec)		
7 Drop Test 45.4 ~ 90.8 76 90.8 ~ 454 61	6		2. The amplitude of vibration :1.5 mm			
Drop Direction: **1 corner / 3 edges / 6 sides each 1time	7	_	0 ~ 45.4 45.4 ~ 90.8 90.8 ~ 454 Over 454	122 76 61 46		



#### 5. PRECAUTION RELATING PRODUCT HANDLING

#### **5.1 SAFETY**

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

#### **5.2 HANDLING**

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM

#### **5.3 STORAGE**

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}$ C  $\pm$   $5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

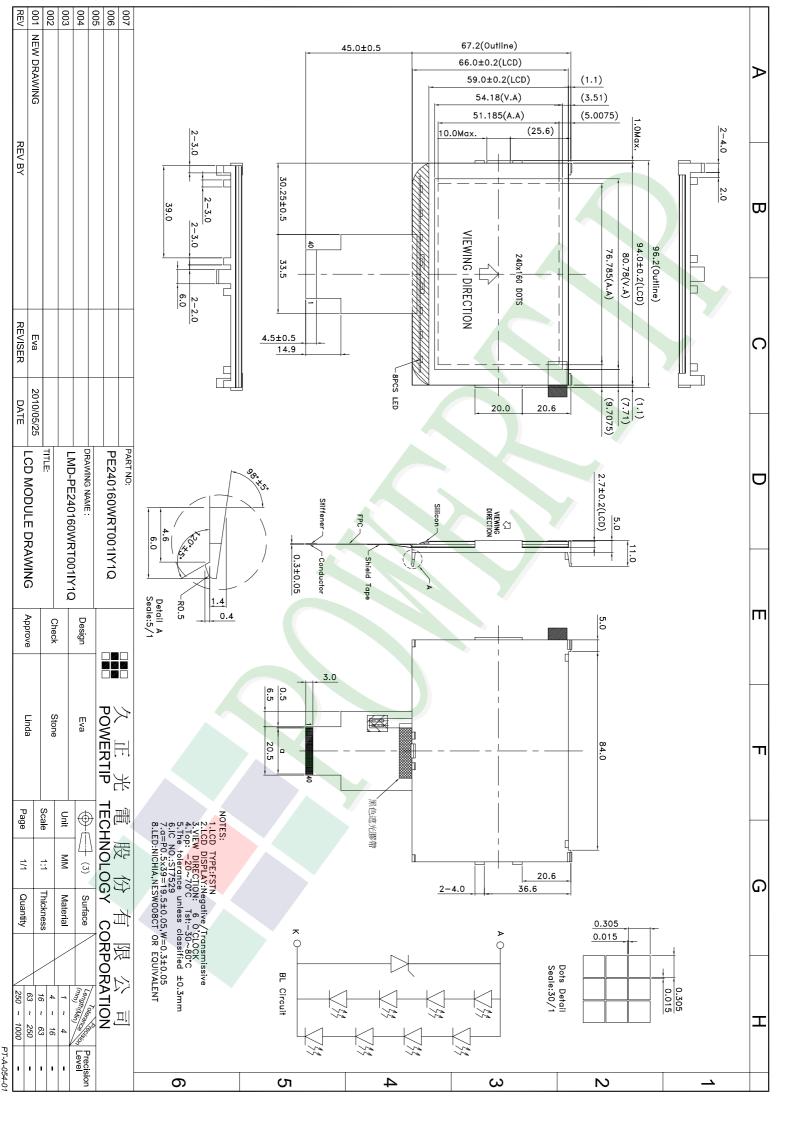
#### 5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

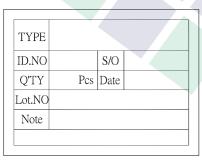
The period is within thirteen months since the date of shipping out under normal using and storage conditions.

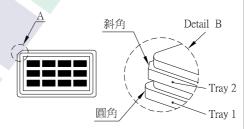
5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



#### Approve Check Contact Ver.001 LCM包裝規格書 LCM Packaging Specifications Eva Linda Stone PKG-PE240160WRT001IY1Q Documents NO. (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) No. Item Model Dimensions (mm) 1Pcs Weight Quantity Total Weight PE240160WRT001IY1O 1 成品 (LCM) 96.2 X 67.2 0.0504 108 5.4432 2 多層薄膜(1)POF 6 OTFILM0BA03ABA 19"X350X0.015 3 TRAY 盤 (2)Tray TYPE24016001BB 352 X 260 X 17.8 24 2.4 0.1 內盒(3)Product Box 6 4 BX36627063ABBA 383 X 270 X 66 0.2692 1.6152 5 OTPLB00PL08ABA 2 550 X 393 X 20 0.0284 保利龍板(4)Polylon board 0.0568 6 外紙箱(5)Carton BX57041027CCBA 570 X 410 X 265 1.4208 1.4208 7 8 9 - 整箱總重量 (Total LCD Weight in carton ): 10.94 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box: no per tray x no of tray 3 18 x no of boxes (2) Total LCM quantity in carton: quantity per box 18 6 108 Use empty tray 空盤 (4)保利龍板 (1)多層薄膜 Polylon board POF Put products into the tray (2)TRAY 盤 Trav (5)外紙箱 Carton Tray stacking (3)內盒 Product Box 特 記 事 項 (REMARK) 3.Tray料號: 1. Label Specifications: Detail B Tray Number: TYPE24016001BB





2.TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.